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H8/300H Tiny Series

Watchdog Timer using Internal Oscillator

Introduction

A watchdog timer operation is performed by using an internal oscillator.

Target Device

H8/3664

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1. Specifications

1. A watchdog timer operation is performed by using an internal oscillator.
2. An internal reset occurs when the TCWD overflows.
3. During normal operation, the LED repeatedly turns on and off at constant intervals and the TCWD is initialized before overflow.
4. If the $\overline{\text{IRQ0}}$ switch (SW) is turned on, the TCWD is not initialized and generates an internal reset when TCWD overflows.
5. The LED is connected to the P74 output pin of port 7.
6. Figure 1.1 shows an example of the $\overline{\text{IRQ0}}$ input pin switch connection.

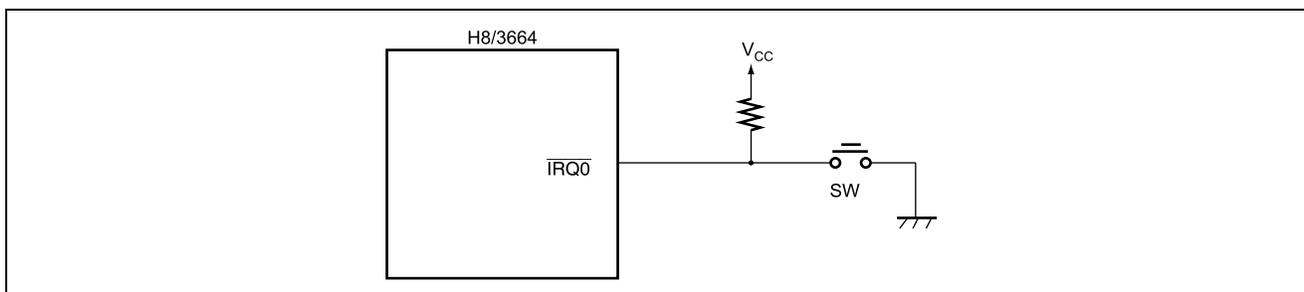


Figure 1 Example of $\overline{\text{IRQ0}}$ Input Pin Switch Connection

2. Description of Functions

1. In this sample task, a watchdog timer operation is implemented using an internal oscillator. Figure 2.1 is a block diagram of the watchdog timer function. The elements of the block diagram are described below.
 - The internal oscillator is an RC circuit oscillator and is used as the input clock for TCWD. The time taken for TCWD to count from 0 to 255 and an internal reset to occur is 0.4 sec (rated value) with a minimum value of 0.2 sec.
 - The timer control/status register WD (TCSRWD) controls writing to TCSRWD and TCWD and watchdog timer operation, and indicates the status of operation.
 - The timer counter WD (TCWD) is an 8-bit readable/writable upward counter that is incremented by the internal clock input. In this sample task, an internal oscillator is selected as the input clock.
 - The timer mode register WD (TMWD) selects an input clock. In this sample task, an internal oscillator is selected.

TCWD overflow cycle is calculated by the following equation:

$$\text{TCWD overflow cycle} = \frac{\text{Internal oscillator overflow time}}{256} \times (256 - \text{re-set value of TCWD})$$

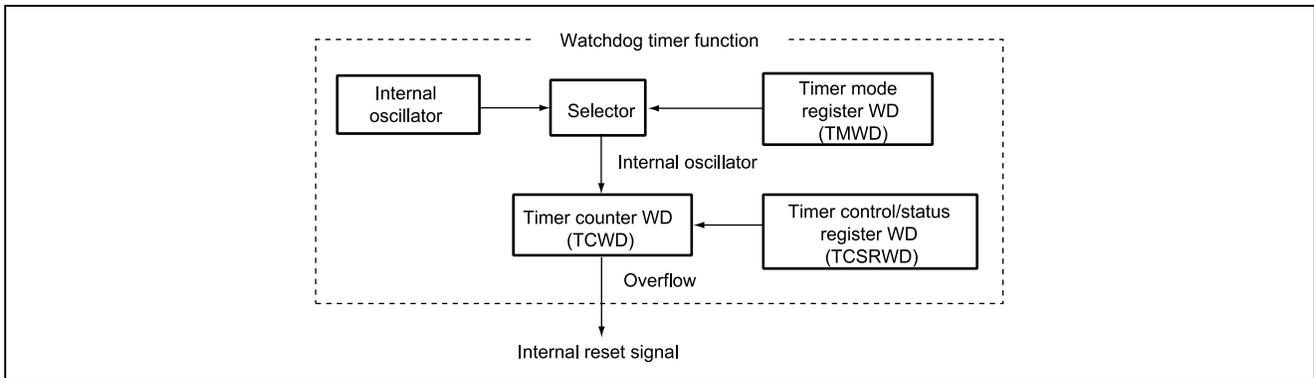


Figure 2.1 Block Diagram of Watchdog Timer Function

2. Table 2.1 lists the function allocation for this sample task. The functions listed in this table are allocated to implement the watchdog timer operation.

Table 2.1 Function Allocation

Function	Description
Internal oscillator	Input clock for TCWD
TCSRWD	Controls the watchdog timer operation and indicates the operation status.
TCWD	Watchdog timer counter
TMWD	Specifies an internal oscillator as the input clock.
$\overline{\text{IRQ0}}$	Switch input pin
P74	LED output

3. Description of Operation

Figure 3.1 illustrates the operation of this sample task. The hardware and software processing are applied as shown in figure 3.1 to implement the watchdog timer operation using the internal oscillator.

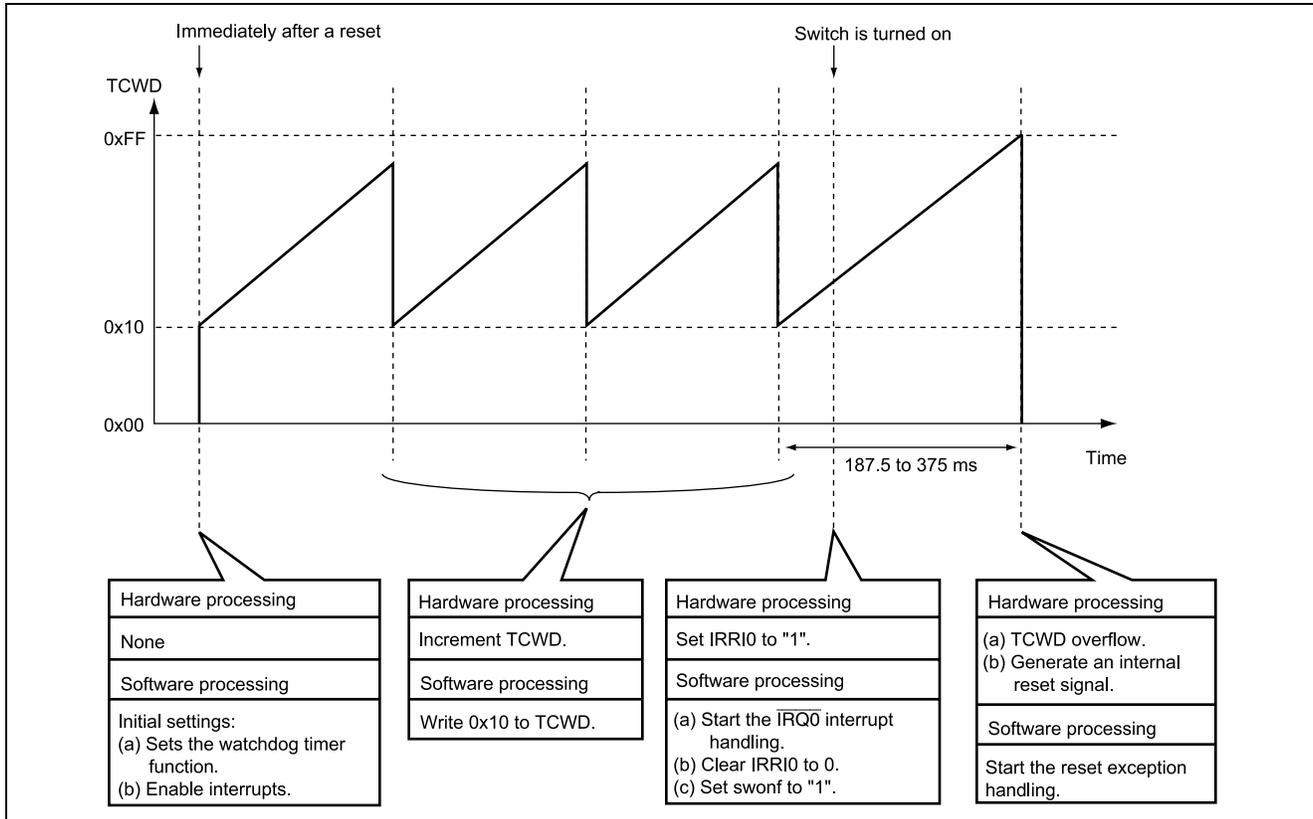


Figure 3.1 Principle of Operation

4. Description of Software

4.1 Modules

Table 4.1 describes the modules used in this sample task.

Table 4.1 Description of Modules

Module Name	Label Name	Function
Main routine	main	Sets the watchdog timer function, enables interrupts, controls LEDs, and checks the state of the switch connected to the IRQ0 pin.
Switch on	irq0int	IRQ0 interrupt handling Sets swonf to 1.

4.2 Arguments

This sample task uses no arguments.

4.3 Internal Registers

The internal registers used in this sample task are described below.

- TCSRWDTimer control status register WD Address: 0xFFC0

Bit	Bit Name	Setting	Function
7	B6W1	0	Bit 6 write disable B6W1 = 0: Enables a write to bit 6 of TCSRWD B6W1 = 1: Disables a write to bit 6 of TCSRWD
6	TCWE	1	Timer counter W write enable TCWE = 0: Disables a write to TCWD. TCWE = 1: Disables a write to TCWD.
5	B4W1	0	Bit 4 write disable B4W1 = 0: Enables a write to bit 4 of TCSRWD. B4W1 = 1: Disables a write to bit 4 of TCSRWD.
4	TCSRWE	1	Timer control/status register W write disable TCSRWE = 0: Enables a write to bits 0 and 2 of TCSRWD. TCSRWE = 1: Disables a write to bits 0 and 2 of TCSRWD.
3	B2W1	1	Bit 2 write disable B4W1 = 0: Enables a write to bit 2 of TCSRWD. B4W1 = 1: Disables a write to bit 2 of TCSRWD.
2	WDON	0	Watchdog timer on WDON = 0: Stops counting up by TCWD. WDON = 1: Starts counting up by TCWD.
1	B0W1	1	Bit 0 write disable B0W1 = 0: Enables a write to bit 0 of TCSRWD B0W1 = 1: Disables a write to bit 0 of TCSRWD
0	WRST	0	Watchdog timer reset WRST = 0: Indicates that TCWD overflow has not occurred WRST = 1: Indicates that TCWD overflow has occurred and an internal reset signal is generated.

4.4 Description of RAM

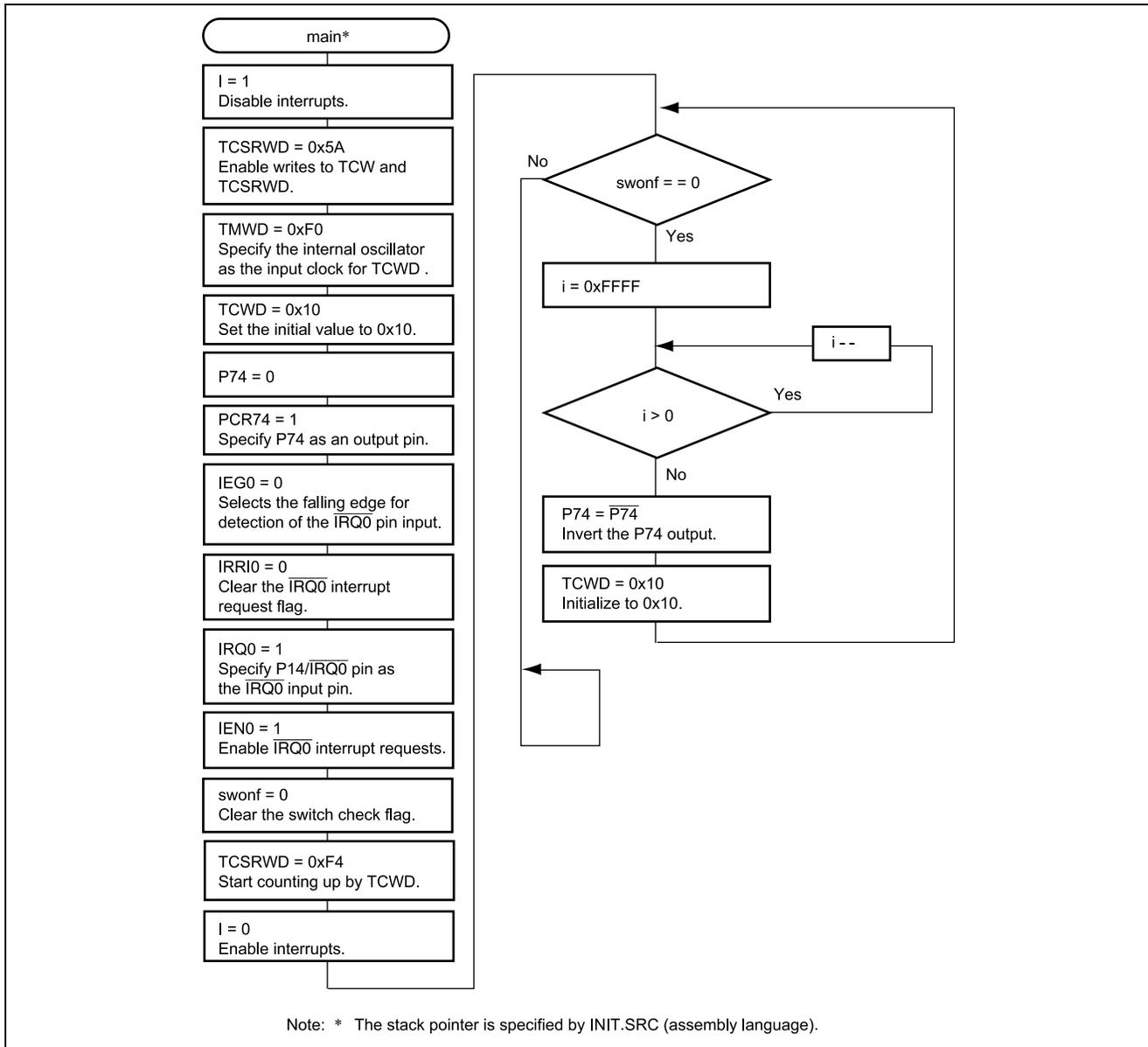
Table 4.2 describes the RAM used in this sample task.

Table 4.2 Description of RAM

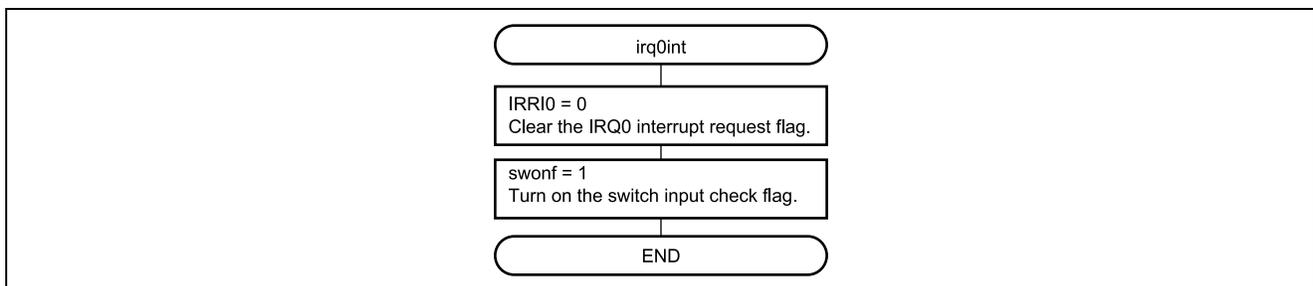
Label Name	Function	Size	Used in
swonf	A flag that is used to determine the on/off state of the switch input.	1 byte	Main routine Switch on

5. Flowcharts

1. Main routine



2. Switch on



6. Program Listing

```

/*****
/*
/* H8/300HN Series -H8/3687-
/* Application Note
/*
/* 'Output 0 and 1 by output compare function'
/*
/* Function
/* : Timer Z output compare function
/*
/*
/* External Clock : 16MHz
/* Internal Clock : 16MHz
/* Sub Clock : 32.768kHz
/*
/*****

#include <machine.h>

/*****
/* Symbol Definition
/*****

struct BIT {
    unsigned char b7:1; /* bit7 */
    unsigned char b6:1; /* bit6 */
    unsigned char b5:1; /* bit5 */
    unsigned char b4:1; /* bit4 */
    unsigned char b3:1; /* bit3 */
    unsigned char b2:1; /* bit2 */
    unsigned char b1:1; /* bit1 */
    unsigned char b0:1; /* bit0 */
};

#define TCR0 *(volatile unsigned char *)0xF700 /* Timer control register_0 */
#define TIORA0 *(volatile unsigned char *)0xF701 /* Timer I/O Control Register A_0 */
#define TCNT0 *(volatile unsigned short *)0xF706 /* Timer counter_0 */
#define GRA0 *(volatile unsigned short *)0xF708 /* General register A_0 */
#define GRB0 *(volatile unsigned short *)0xF70A /* General register B_0 */
#define TCR1 *(volatile unsigned char *)0xF710 /* Timer control register_1 */
#define TIORA1 *(volatile unsigned char *)0xF711 /* Timer I/O Control Register A_1 */
#define TSTR *(volatile unsigned char *)0xF720 /* Timer start register */
#define TMDR *(volatile unsigned char *)0xF721 /* Timer mode register */
#define TPMM *(volatile unsigned char *)0xF722 /* Timer PWM mode register */
#define TFCCR *(volatile unsigned char *)0xF723 /* Timer function control register */
#define TOEMR *(volatile unsigned char *)0xF724 /* Timer output master enable register */
#define TOCCR *(volatile unsigned char *)0xF725 /* Timer output control register */

/*****
/* Function define
/*****

extern void INIT ( void ); /* SP Set
void main ( void );

```

```

/*****
/*  Vector Address
/*****
#pragma section      V1                      /* VECTOR SECTOIN SET          */
void (*const VEC_TBL1[])(void) = {
    INIT                      /* 00 Reset                    */
};

#pragma section                      /* P                            */
/*****
/*  Main Program
/*****
void main ( void )
{
    set_imask_ccr(1);          /* Interrupt Disable          */

    TSTR = 0xFC;              /* TCNT0 count stop          */
    TMDR = 0x0E;              /* TCNT0,TCNT1 Single Mode   */
    TPMR = 0x88;              /* FTIOB0 is Normal Mode     */
    TFCR = 0x80;              /* Chanel 0,1 is Normal Mode */
    TOER = 0xFC;              /* FTIOA0,FTIOB0 Output Enable */
    TCR0 = 0x01;              /* Rising edge, phi/2 Clock count */
    TOCR = 0x01;              /* First level set FTIOA0:1 FTIOB0:0 */
    TIORA0 = 0xA9;           /* 0 output by GRA compare match */
                                /* 1 output by GRB compare match */

    GRA0 = 0x4000;           /* Set GRA0                  */
    GRB0 = 0x8000;           /* Set GRB0                  */
    TCNT0 = 0x0000;          /* Set TCNT0                 */
    TSTR = 0xFD;              /* TCNT0 count start        */

    set_imask_ccr(0);          /* Interrupt Enable          */
    while(1);
}

```

Link address specifications

Section Name	Address
CV1	0x0000
CV2	0x001C
P	0x0100
B	0xFB80

Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Sep.29.03	—	First edition issued

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